

## Features

- Fast Read Access Time – 150 ns
- Automatic Page Write Operation
  - Internal Address and Data Latches for 64 Bytes
- Fast Write Cycle Times
  - Page Write Cycle Time: 10 ms Maximum (Standard)  
2 ms Maximum (Option – Ref. AT28HC64BF Datasheet)
  - 1 to 64-byte Page Write Operation
- Low Power Dissipation
  - 40 mA Active Current
  - 100  $\mu$ A CMOS Standby Current
- Hardware and Software Data Protection
- DATA Polling and Toggle Bit for End of Write Detection
- High Reliability CMOS Technology
  - Endurance: 100,000 Cycles
  - Data Retention: 10 Years
- Single 5V  $\pm 10\%$  Supply
- CMOS and TTL Compatible Inputs and Outputs
- JEDEC Approved Byte-wide Pinout
- Industrial Temperature Ranges
- Green (Pb/Halide-free) Packaging Option

## 1. Description

The AT28C64B is a high-performance electrically-erasable and programmable read-only memory (EEPROM). Its 64K of memory is organized as 8,192 words by 8 bits. Manufactured with Atmel's advanced nonvolatile CMOS technology, the device offers access times to 150 ns with power dissipation of just 220 mW. When the device is deselected, the CMOS standby current is less than 100  $\mu$ A.

The AT28C64B is accessed like a Static RAM for the read or write cycle without the need for external components. The device contains a 64-byte page register to allow writing of up to 64 bytes simultaneously. During a write cycle, the addresses and 1 to 64 bytes of data are internally latched, freeing the address and data bus for other operations. Following the initiation of a write cycle, the device will automatically write the latched data using an internal control timer. The end of a write cycle can be detected by DATA POLLING of I/O7. Once the end of a write cycle has been detected, a new access for a read or write can begin.

Atmel's AT28C64B has additional features to ensure high quality and manufacturability. The device utilizes internal error correction for extended endurance and improved data retention characteristics. An optional software data protection mechanism is available to guard against inadvertent writes. The device also includes an extra 64 bytes of EEPROM for device identification or tracking.



**64K (8K x 8)  
Parallel  
EEPROM with  
Page Write and  
Software Data  
Protection**

**AT28C64B**

勝特力材料 886-3-5753170  
勝特力电子(上海) 86-21-54151736  
勝特力电子(深圳) 86-755-83298787  
[Http://www.100y.com.tw](http://www.100y.com.tw)

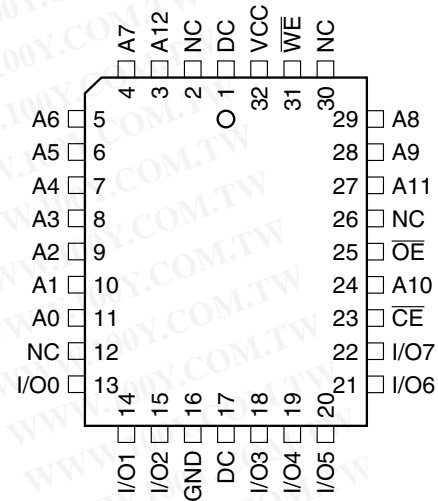
0270K-PEEPR-10/06



## 2. Pin Configurations

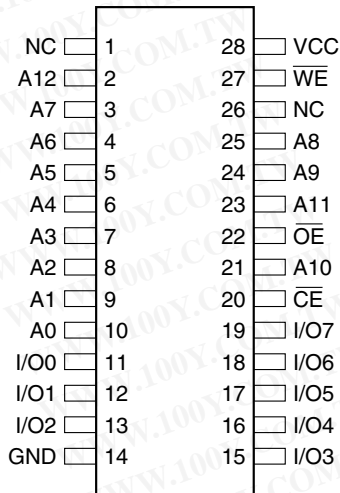
| Pin Name        | Function            |
|-----------------|---------------------|
| A0 - A12        | Addresses           |
| $\overline{CE}$ | Chip Enable         |
| $\overline{OE}$ | Output Enable       |
| $\overline{WE}$ | Write Enable        |
| I/O0 - I/O7     | Data Inputs/Outputs |
| NC              | No Connect          |
| DC              | Don't Connect       |

### 2.2 32-lead PLCC Top View

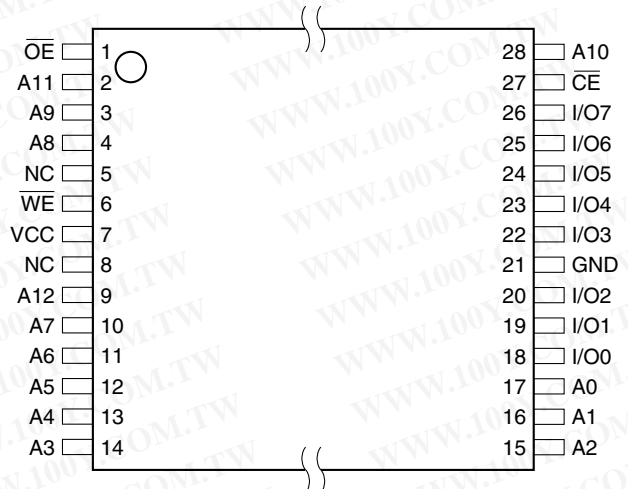


Note: PLCC package pins 1 and 17 are Don't Connect.

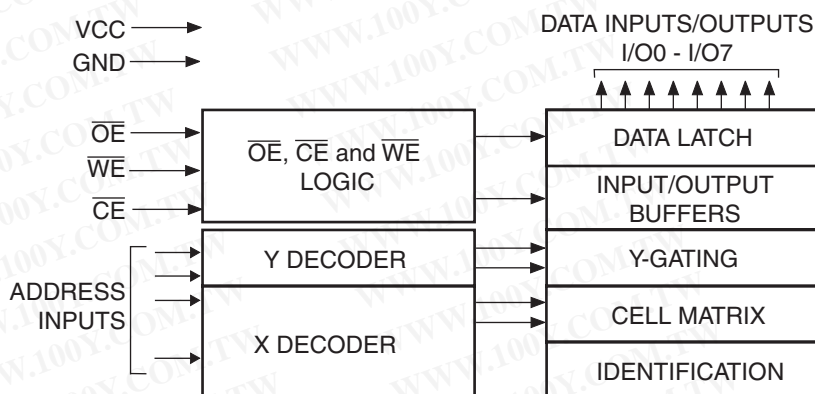
### 2.1 28-lead PDIP, 28-lead SOIC Top View



### 2.3 28-lead TSOP Top View



### 3. Block Diagram



### 4. Device Operation

#### 4.1 Read

The AT28C64B is accessed like a Static RAM. When  $\overline{CE}$  and  $\overline{OE}$  are low and  $\overline{WE}$  is high, the data stored at the memory location determined by the address pins is asserted on the outputs. The outputs are put in the high-impedance state when either  $\overline{CE}$  or  $\overline{OE}$  is high. This dual line control gives designers flexibility in preventing bus contention in their systems.

#### 4.2 Byte Write

A low pulse on the  $\overline{WE}$  or  $\overline{CE}$  input with  $\overline{CE}$  or  $\overline{WE}$  low (respectively) and  $\overline{OE}$  high initiates a write cycle. The address is latched on the falling edge of  $\overline{CE}$  or  $\overline{WE}$ , whichever occurs last. The data is latched by the first rising edge of  $\overline{CE}$  or  $\overline{WE}$ . Once a byte write has been started, it will automatically time itself to completion. Once a programming operation has been initiated and for the duration of  $t_{WC}$ , a read operation will effectively be a polling operation.

#### 4.3 Page Write

The page write operation of the AT28C64B allows 1 to 64 bytes of data to be written into the device during a single internal programming period. A page write operation is initiated in the same manner as a byte write; after the first byte is written, it can then be followed by 1 to 63 additional bytes. Each successive byte must be loaded within  $150 \mu s$  ( $t_{BLC}$ ) of the previous byte. If the  $t_{BLC}$  limit is exceeded, the AT28C64B will cease accepting data and commence the internal programming operation. All bytes during a page write operation must reside on the same page as defined by the state of the A6 to A12 inputs. For each  $\overline{WE}$  high to low transition during the page write operation, A6 to A12 must be the same.

The A0 to A5 inputs specify which bytes within the page are to be written. The bytes may be loaded in any order and may be altered within the same load period. Only bytes which are specified for writing will be written; unnecessary cycling of other bytes within the page does not occur.



#### 4.4 DATA Polling

The AT28C64B features DATA Polling to indicate the end of a write cycle. During a byte or page write cycle an attempted read of the last byte written will result in the complement of the written data to be presented on I/O7. Once the write cycle has been completed, true data is valid on all outputs, and the next write cycle may begin. DATA Polling may begin at any time during the write cycle.

#### 4.5 Toggle Bit

In addition to DATA Polling, the AT28C64B provides another method for determining the end of a write cycle. During the write operation, successive attempts to read data from the device will result in I/O6 toggling between one and zero. Once the write has completed, I/O6 will stop toggling, and valid data will be read. Toggle bit reading may begin at any time during the write cycle.

#### 4.6 Data Protection

If precautions are not taken, inadvertent writes may occur during transitions of the host system power supply. Atmel® has incorporated both hardware and software features that will protect the memory against inadvertent writes.

##### 4.6.1 Hardware Data Protection

Hardware features protect against inadvertent writes to the AT28C64B in the following ways: (a)  $V_{CC}$  sense – if  $V_{CC}$  is below 3.8 V (typical), the write function is inhibited; (b)  $V_{CC}$  power-on delay – once  $V_{CC}$  has reached 3.8 V, the device will automatically time out 5 ms (typical) before allowing a write; (c) write inhibit – holding any one of  $\overline{OE}$  low,  $\overline{CE}$  high, or  $\overline{WE}$  high inhibits write cycles; and (d) noise filter – pulses of less than 15 ns (typical) on the  $\overline{WE}$  or  $\overline{CE}$  inputs will not initiate a write cycle.

##### 4.6.2 Software Data Protection

A software controlled data protection feature has been implemented on the AT28C64B. When enabled, the software data protection (SDP), will prevent inadvertent writes. The SDP feature may be enabled or disabled by the user; the AT28C64B is shipped from Atmel with SDP disabled.

SDP is enabled by the user issuing a series of three write commands in which three specific bytes of data are written to three specific addresses (see “Software Data Protection Algorithms” on [page 10](#)). After writing the 3-byte command sequence and waiting  $t_{WC}$ , the entire AT28C64B will be protected against inadvertent writes. It should be noted that even after SDP is enabled, the user may still perform a byte or page write to the AT28C64B by preceding the data to be written by the same 3-byte command sequence used to enable SDP.

Once set, SDP remains active unless the disable command sequence is issued. Power transitions do not disable SDP, and SDP protects the AT28C64B during power-up and power-down conditions. All command sequences must conform to the page write timing specifications. The data in the enable and disable command sequences is not actually written into the device; their addresses may still be written with user data in either a byte or page write operation.

After setting SDP, any attempt to write to the device without the 3-byte command sequence will start the internal write timers. No data will be written to the device. However, for the duration of  $t_{WC}$ , read operations will effectively be polling operations.

#### 4.7 Device Identification

An extra 64 bytes of EEPROM memory are available to the user for device identification. By raising A9 to 12V  $\pm 0.5V$  and using address locations 1FC0H to 1FFFH, the additional bytes may be written to or read from in the same manner as the regular memory array.

## 5. DC and AC Operating Range

| AT28C64B-15                  |              |
|------------------------------|--------------|
| Operating Temperature (Case) | -40°C - 85°C |
| V <sub>CC</sub> Power Supply | 5V ±10%      |

## 6. Operating Modes

| Mode                  | $\overline{CE}$ | $\overline{OE}$               | $\overline{WE}$ | I/O              |
|-----------------------|-----------------|-------------------------------|-----------------|------------------|
| Read                  | V <sub>IL</sub> | V <sub>IL</sub>               | V <sub>IH</sub> | D <sub>OUT</sub> |
| Write <sup>(2)</sup>  | V <sub>IL</sub> | V <sub>IH</sub>               | V <sub>IL</sub> | D <sub>IN</sub>  |
| Standby/Write Inhibit | V <sub>IH</sub> | X <sup>(1)</sup>              | X               | High Z           |
| Write Inhibit         | X               | X                             | V <sub>IH</sub> |                  |
| Write Inhibit         | X               | V <sub>IL</sub>               | X               |                  |
| Output Disable        | X               | V <sub>IH</sub>               | X               | High Z           |
| Chip Erase            | V <sub>IL</sub> | V <sub>H</sub> <sup>(3)</sup> | V <sub>IL</sub> | High Z           |

- Notes:
1. X can be V<sub>IL</sub> or V<sub>IH</sub>.
  2. See "AC Write Waveforms" on page 8.
  3. V<sub>H</sub> = 12.0V ±0.5V.

## 7. Absolute Maximum Ratings\*

|   |                                 |
|---|---------------------------------|
| Temperature Under Bias .....  | -55°C to +125°C                 |
| Storage Temperature .....   | -65°C to +150°C                 |
| All Input Voltages<br>(including NC Pins)<br>with Respect to Ground ..... | -0.6V to +6.25V                 |
| All Output Voltages<br>with Respect to Ground .....                       | -0.6V to V <sub>CC</sub> + 0.6V |
| Voltage on $\overline{OE}$ and A9<br>with Respect to Ground .....         | -0.6V to +13.5V                 |

\*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability

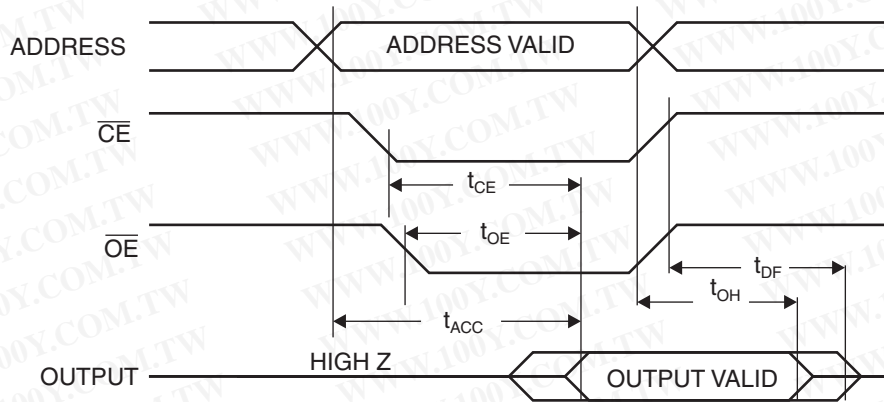
## 8. DC Characteristics

| Symbol           | Parameter                            | Condition  | Min | Max  | Units |
|------------------|--------------------------------------|--|-----|------|-------|
| I <sub>LI</sub>  | Input Load Current                   | V <sub>IN</sub> = 0V to V <sub>CC</sub> + 1V                     |     | 10   | μA    |
| I <sub>LO</sub>  | Output Leakage Current               | V <sub>I/O</sub> = 0V to V <sub>CC</sub>                         |     | 10   | μA    |
| I <sub>SB1</sub> | V <sub>CC</sub> Standby Current CMOS | $\overline{CE}$ = V <sub>CC</sub> - 0.3V to V <sub>CC</sub> + 1V |     | 100  | μA    |
| I <sub>SB2</sub> | V <sub>CC</sub> Standby Current TTL  | $\overline{CE}$ = 2.0V to V <sub>CC</sub> + 1V                   |     | 2    | mA    |
| I <sub>CC</sub>  | V <sub>CC</sub> Active Current       | f = 5 MHz; I <sub>OUT</sub> = 0 mA                               |     | 40   | mA    |
| V <sub>IL</sub>  | Input Low Voltage                    |  |     | 0.8  | V     |
| V <sub>IH</sub>  | Input High Voltage                   |  | 2.0 |      | V     |
| V <sub>OL</sub>  | Output Low Voltage                   | I <sub>OL</sub> = 2.1 mA   |     | 0.40 | V     |
| V <sub>OH</sub>  | Output High Voltage                  | I <sub>OH</sub> = -400 μA  | 2.4 |      | V     |

## 9. AC Read Characteristics

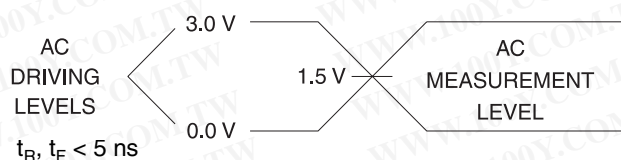
| Symbol            | Parameter   | AT28C64B-15 |     | Units |
|-------------------|---|-------------|-----|-------|
|                   |   | Min         | Max |       |
| $t_{ACC}$         | Address to Output Delay   |             | 150 | ns    |
| $t_{CE}^{(1)}$    | $\overline{CE}$ to Output Delay   |             | 150 | ns    |
| $t_{OE}^{(2)}$    | $\overline{OE}$ to Output Delay   | 0           | 70  | ns    |
| $t_{DF}^{(3)(4)}$ | $\overline{CE}$ or $\overline{OE}$ to Output Float                                      | 0           | 50  | ns    |
| $t_{OH}$          | Output Hold from $\overline{OE}$ , $\overline{CE}$ or Address, whichever occurred first | 0           |     | ns    |

## 10. AC Read Waveforms<sup>(1)(2)(3)(4)</sup>

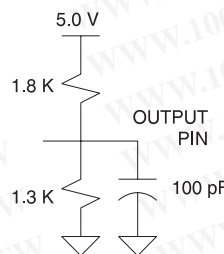


- Notes:
- $\overline{CE}$  may be delayed up to  $t_{ACC} - t_{CE}$  after the address transition without impact on  $t_{ACC}$ .
  - $\overline{OE}$  may be delayed up to  $t_{CE} - t_{OE}$  after the falling edge of  $\overline{CE}$  without impact on  $t_{CE}$  or by  $t_{ACC} - t_{OE}$  after an address change without impact on  $t_{ACC}$ .
  - $t_{DF}$  is specified from  $\overline{OE}$  or  $\overline{CE}$  whichever occurs first ( $C_L = 5$  pF).
  - This parameter is characterized and is not 100% tested.

## 11. Input Test Waveforms and Measurement Level



## 12. Output Test Load



## 13. Pin Capacitance

$f = 1 \text{ MHz}$ ,  $T = 25^\circ\text{C}^{(1)}$

| Symbol    | Typ | Max | Units | Conditions     |
|-----------|-----|-----|-------|----------------|
| $C_{IN}$  | 4   | 6   | pF    | $V_{IN} = 0V$  |
| $C_{OUT}$ | 8   | 12  | pF    | $V_{OUT} = 0V$ |

Note: 1. This parameter is characterized and is not 100% tested.

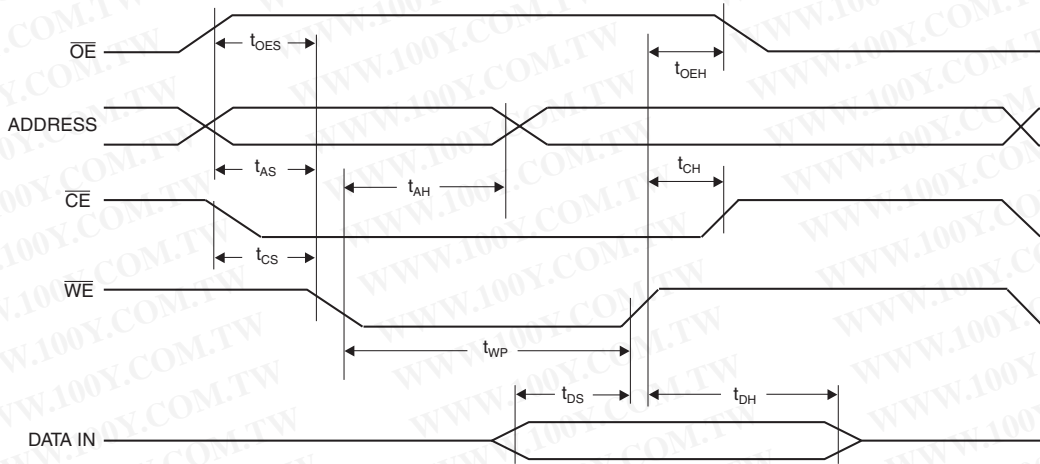


## 14. AC Write Characteristics

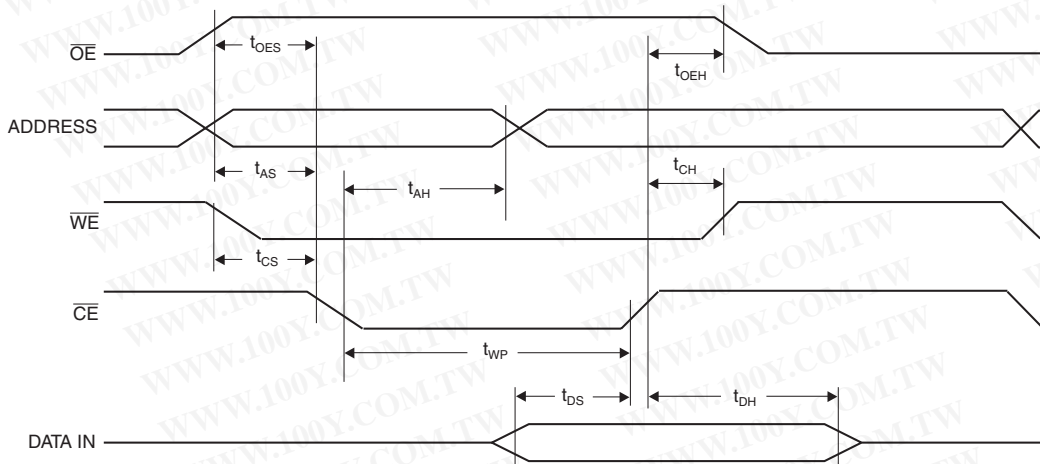
| Symbol            | Parameter  | Min | Max | Units |
|-------------------|--|-----|-----|-------|
| $t_{AS}, t_{OES}$ | Address, $\overline{OE}$ Setup Time                      | 0   |     | ns    |
| $t_{AH}$          | Address Hold Time  | 50  |     | ns    |
| $t_{CS}$          | Chip Select Setup Time                                   | 0   |     | ns    |
| $t_{CH}$          | Chip Select Hold Time                                    | 0   |     | ns    |
| $t_{WP}$          | Write Pulse Width ( $\overline{WE}$ or $\overline{CE}$ ) | 100 |     | ns    |
| $t_{DS}$          | Data Setup Time  | 50  |     | ns    |
| $t_{DH}, t_{OEH}$ | Data, $\overline{OE}$ Hold Time                          | 0   |     | ns    |

## 15. AC Write Waveforms

### 15.1 $\overline{WE}$ Controlled



### 15.2 $\overline{CE}$ Controlled

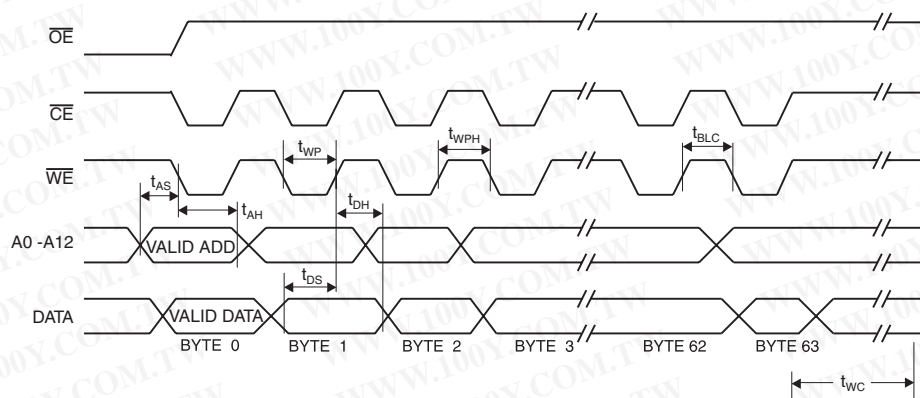




## 16. Page Mode Characteristics

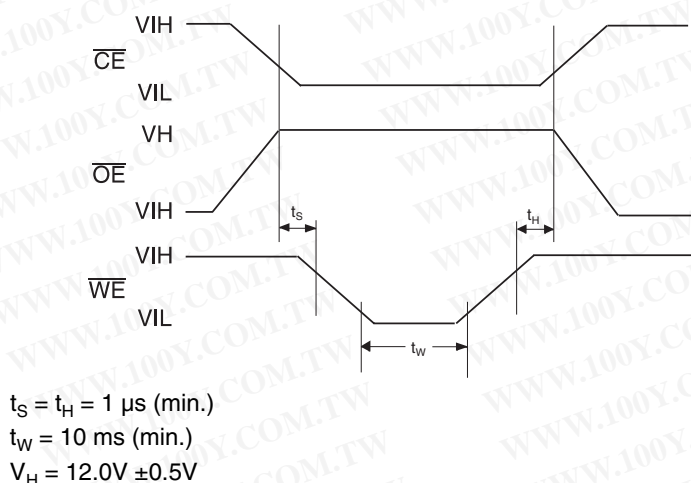
| Symbol    | Parameter   | Min | Max | Units   |
|-----------|---|-----|-----|---------|
| $t_{WC}$  | Write Cycle Time  |     | 10  | ms      |
| $t_{WC}$  | Write Cycle Time (option available – Ref. AT28HC64BF datasheet) |     | 2   | ms      |
| $t_{AS}$  | Address Setup Time  | 0   |     | ns      |
| $t_{AH}$  | Address Hold Time   | 50  |     | ns      |
| $t_{DS}$  | Data Setup Time   | 50  |     | ns      |
| $t_{DH}$  | Data Hold Time  | 0   |     | ns      |
| $t_{WP}$  | Write Pulse Width   | 100 |     | ns      |
| $t_{BLC}$ | Byte Load Cycle Time  |     | 150 | $\mu$ s |
| $t_{WPH}$ | Write Pulse Width High  | 50  |     | ns      |

## 17. Page Mode Write Waveforms<sup>(1)(2)</sup>

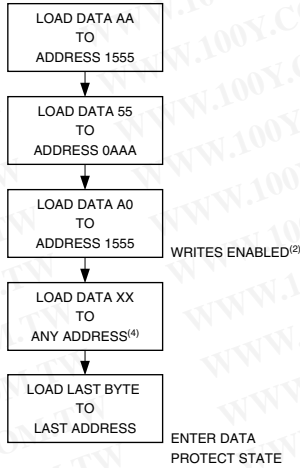


- Notes:
1. A6 through A12 must specify the same page address during each high to low transition of  $\overline{WE}$  (or  $\overline{CE}$ ).
  2.  $\overline{OE}$  must be high only when  $\overline{WE}$  and  $\overline{CE}$  are both low.

## 18. Chip Erase Waveforms

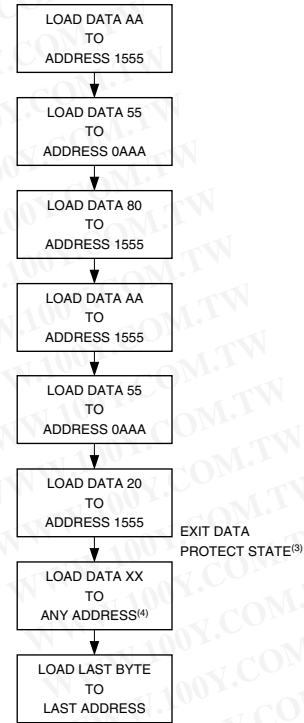


## 19. Software Data Protection Enable Algorithm<sup>(1)</sup>



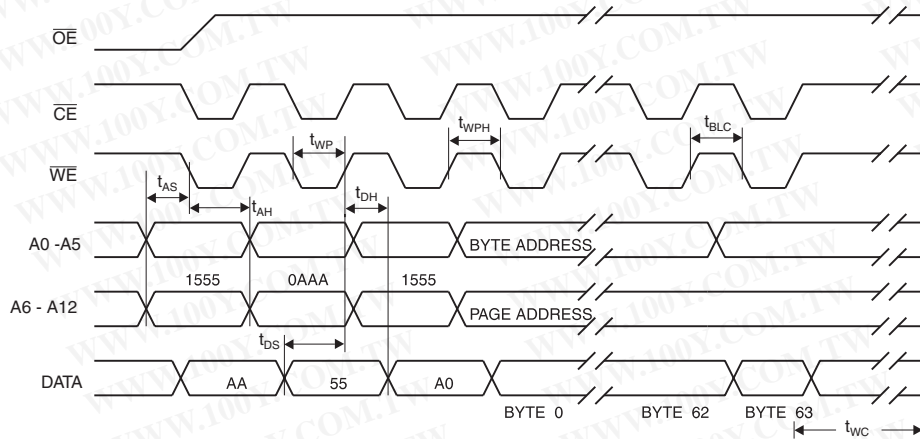
- Notes:
1. Data Format: I/O7 - I/O0 (Hex); Address Format: A12 - A0 (Hex).
  2. Write Protect state will be activated at end of write even if no other data is loaded.
  3. Write Protect state will be deactivated at end of write period even if no other data is loaded.
  4. 1 to 64 bytes of data are loaded.

## 20. Software Data Protection Disable Algorithm<sup>(1)</sup>



- Notes:
1. Data Format: I/O7 - I/O0 (Hex); Address Format: A12 - A0 (Hex).
  2. Write Protect state will be activated at end of write even if no other data is loaded.
  3. Write Protect state will be deactivated at end of write period even if no other data is loaded.
  4. 1 to 64 bytes of data are loaded.

## 21. Software Protected Write Cycle Waveforms<sup>(1)(2)</sup>



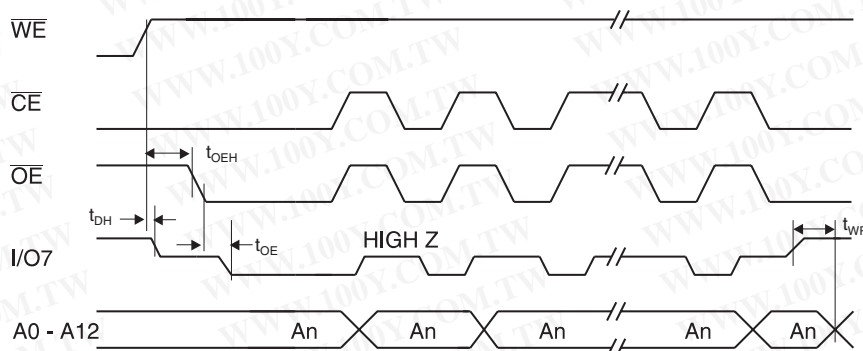
- Notes:
1. A6 through A12 must specify the same page address during each high to low transition of  $\overline{WE}$  (or  $\overline{CE}$ ) after the software code has been entered.
  2.  $\overline{OE}$  must be high only when  $\overline{WE}$  and  $\overline{CE}$  are both low.

## 22. Data Polling Characteristics<sup>(1)</sup>

| Symbol          | Parameter                                       | Min | Typ | Max | Units |
|-----------------|---|-----|-----|-----|-------|
| $t_{DH}$        | Data Hold Time                                  | 0   |     |     | ns    |
| $t_{OE\bar{H}}$ | $\bar{O}\bar{E}$ Hold Time                      | 0   |     |     | ns    |
| $t_{OE}$        | $\bar{O}\bar{E}$ to Output Delay <sup>(1)</sup> |     |     |     | ns    |
| $t_{WR}$        | Write Recovery Time                             | 0   |     |     | ns    |

Notes: 1. These parameters are characterized and not 100% tested. See "AC Read Characteristics" on page 6.

## 23. Data Polling Waveforms



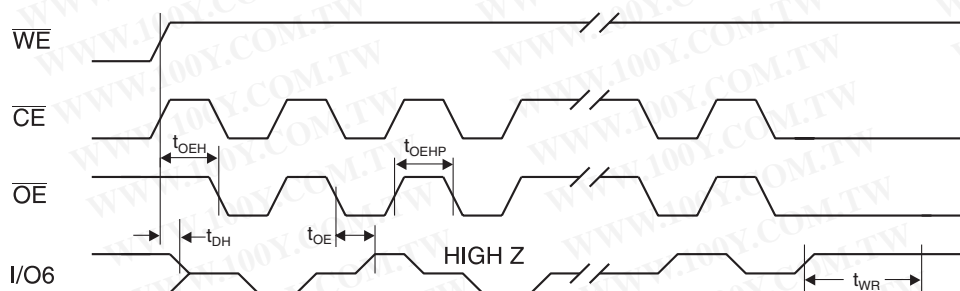
## 24. Toggle Bit Characteristics<sup>(1)</sup>

| Symbol          | Parameter                                       | Min | Typ | Max | Units |
|-----------------|---|-----|-----|-----|-------|
| $t_{DH}$        | Data Hold Time                                  | 10  |     |     | ns    |
| $t_{OE\bar{H}}$ | $\bar{O}\bar{E}$ Hold Time                      | 10  |     |     | ns    |
| $t_{OE}$        | $\bar{O}\bar{E}$ to Output Delay <sup>(2)</sup> |     |     |     | ns    |
| $t_{OEHP}$      | $\bar{O}\bar{E}$ High Pulse                     | 150 |     |     | ns    |
| $t_{WR}$        | Write Recovery Time                             | 0   |     |     | ns    |

Notes: 1. These parameters are characterized and not 100% tested.

2. See "AC Read Characteristics" on page 6.

## 25. Toggle Bit Waveforms<sup>(1)(2)(3)</sup>



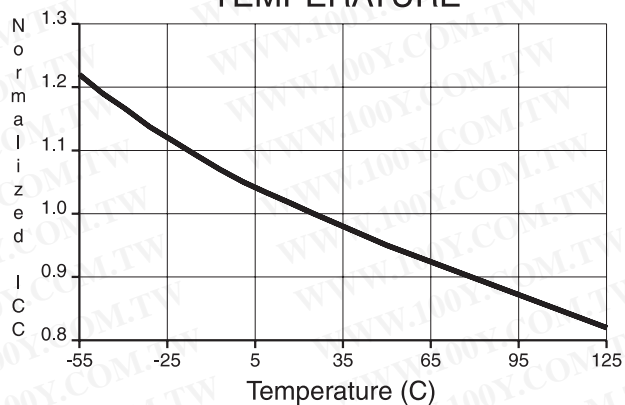
Notes: 1. Toggling either  $\bar{O}\bar{E}$  or  $\bar{C}\bar{E}$  or both  $\bar{O}\bar{E}$  and  $\bar{C}\bar{E}$  will operate toggle bit.

2. Beginning and ending state of I/O6 will vary.

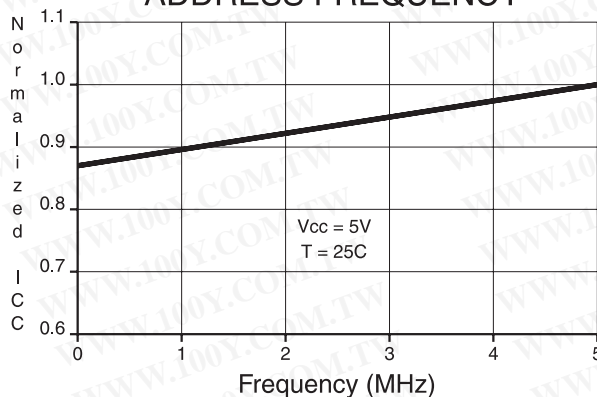
3. Any address location may be used but the address should not vary.

## 26. Normalized $I_{CC}$ Graphs

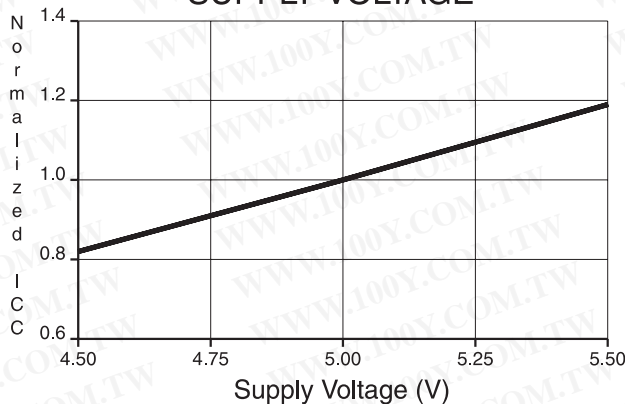
NORMALIZED SUPPLY CURRENT vs.  
TEMPERATURE



NORMALIZED SUPPLY CURRENT vs.  
ADDRESS FREQUENCY



NORMALIZED SUPPLY CURRENT vs.  
SUPPLY VOLTAGE



勝特力材料 886-3-5753170  
 勝特力电子(上海) 86-21-54151736  
 勝特力电子(深圳) 86-755-83298787  
[Http://www.100y.com.tw](http://www.100y.com.tw)



## 27. Ordering Information<sup>(1)</sup>

### 27.1 Standard Package

| t <sub>ACC</sub><br>(ns) | I <sub>CC</sub> (mA) |         | Ordering Code  | Package                   | Operation Range                 |
|--------------------------|----------------------|---------|--|---------------------------|---------------------------------|
|                          | Active               | Standby |  |                           |                                 |
| 150                      | 40                   | 0.1     | AT28C64B-15JI<br>AT28C64B-15PI<br>AT28C64B-15SI<br>AT28C64B-15TI | 32J<br>28P6<br>28S<br>28T | Industrial<br>(-40° C to 85° C) |

Note: 1. See "Valid Part Numbers" on page 13.

### 27.2 Green Package Option (Pb/Halide-free)

| t <sub>ACC</sub><br>(ns) | I <sub>CC</sub> (mA) |         | Ordering Code  | Package                   | Operation Range                 |
|--------------------------|----------------------|---------|--|---------------------------|---------------------------------|
|                          | Active               | Standby |  |                           |                                 |
| 150                      | 40                   | 0.1     | AT28C64B-15JU<br>AT28C64B-15SU<br>AT28C64B-15TU<br>AT28C64B-15PU | 32J<br>28S<br>28T<br>28P6 | Industrial<br>(-40° C to 85° C) |

## 28. Valid Part Numbers

The following table lists standard Atmel products that can be ordered.

| Device Numbers | Speed | Package and Temperature Combinations |
|----------------|-------|--------------------------------------|
| AT28C64B       | 15    | JI, JU, PI, SI, SU, TI, TU, PU       |

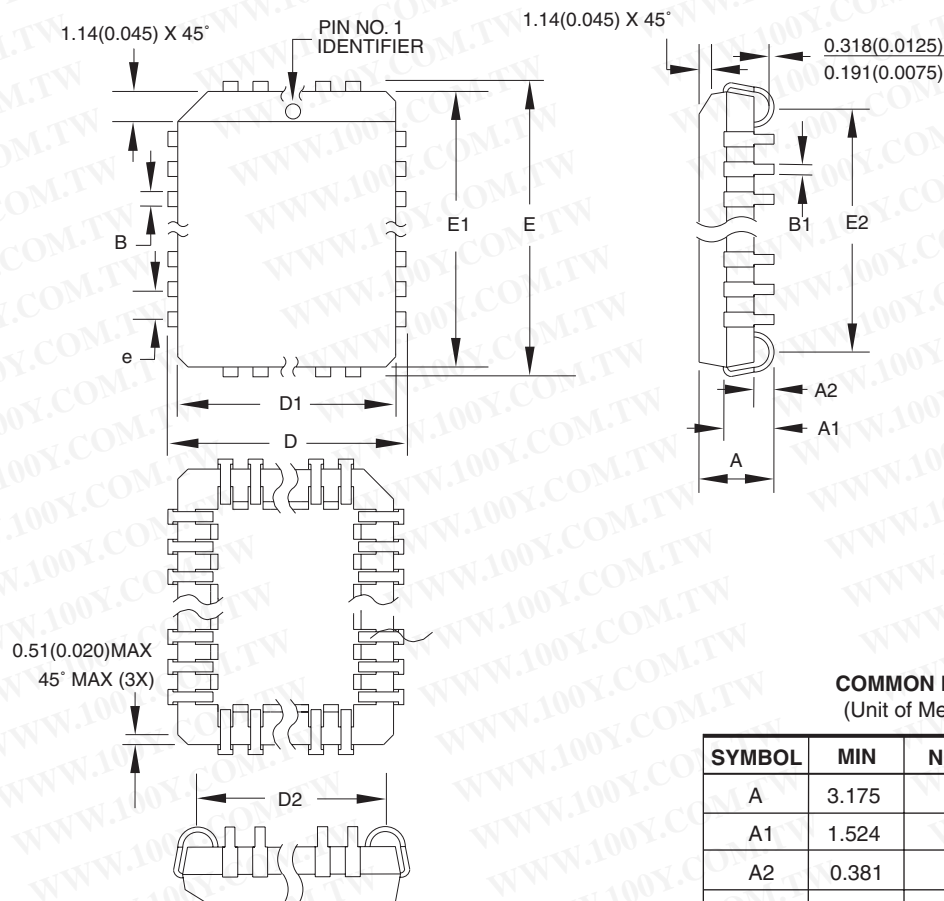
## 29. Die Products

Reference Section: Parallel EEPROM Die Products

| Package Type |  |
|--------------|--|
| 32J          | 32-lead, Plastic J-leaded Chip Carrier (PLCC)                |
| 28P6         | 28-lead, 0.600" Wide, Plastic Dual Inline Package (PDIP)     |
| 28S          | 28-lead, 0.300" Wide, Plastic Gull Wing Small Outline (SOIC) |
| 28T          | 28-lead, Plastic Thin Small Outline Package (TSOP)           |

## 30. Packaging Information

### 30.1 32J – PLCC



- Notes:
1. This package conforms to JEDEC reference MS-016, Variation AE.
  2. Dimensions D1 and E1 do not include mold protrusion.  
Allowable protrusion is .010"(0.254 mm) per side. Dimension D1 and E1 include mold mismatch and are measured at the extreme material condition at the upper or lower parting line.
  3. Lead coplanarity is 0.004" (0.102 mm) maximum.

**COMMON DIMENSIONS**  
(Unit of Measure = mm)

| SYMBOL | MIN       | NOM | MAX    | NOTE   |
|--------|-----------|-----|--------|--------|
| A      | 3.175     | —   | 3.556  |        |
| A1     | 1.524     | —   | 2.413  |        |
| A2     | 0.381     | —   | —      |        |
| D      | 12.319    | —   | 12.573 |        |
| D1     | 11.354    | —   | 11.506 | Note 2 |
| D2     | 9.906     | —   | 10.922 |        |
| E      | 14.859    | —   | 15.113 |        |
| E1     | 13.894    | —   | 14.046 | Note 2 |
| E2     | 12.471    | —   | 13.487 |        |
| B      | 0.660     | —   | 0.813  |        |
| B1     | 0.330     | —   | 0.533  |        |
| e      | 1.270 TYP |     |        |        |

10/04/01



2325 Orchard Parkway  
San Jose, CA 95131

| TITLE |
|-------|
|-------|

**32J**, 32-lead, Plastic J-leaded Chip Carrier (PLCC)

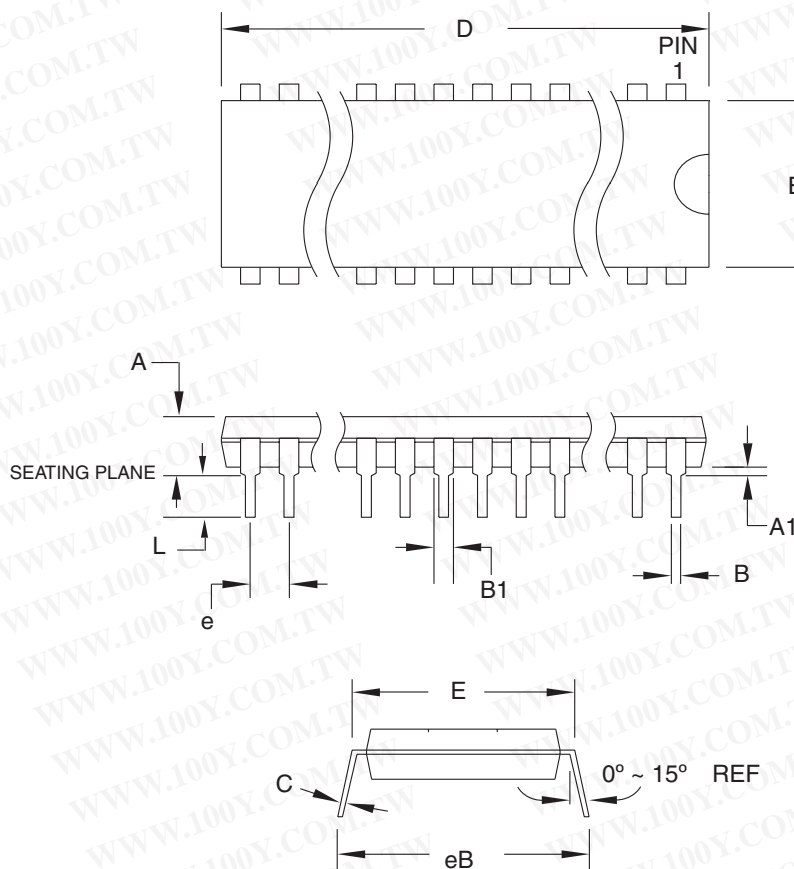
**DRAWING NO.**

32J

REV.

B

## 30.2 28P6 – PDIP



**COMMON DIMENSIONS**  
(Unit of Measure = mm)

| SYMBOL | MIN       | NOM | MAX    | NOTE   |
|--------|-----------|-----|--------|--------|
| A      | —         | —   | 4.826  |        |
| A1     | 0.381     | —   | —      |        |
| D      | 36.703    | —   | 37.338 | Note 2 |
| E      | 15.240    | —   | 15.875 |        |
| E1     | 13.462    | —   | 13.970 | Note 2 |
| B      | 0.356     | —   | 0.559  |        |
| B1     | 1.041     | —   | 1.651  |        |
| L      | 3.048     | —   | 3.556  |        |
| C      | 0.203     | —   | 0.381  |        |
| eB     | 15.494    | —   | 17.526 |        |
| e      | 2.540 TYP |     |        |        |

- Notes:
1. This package conforms to JEDEC reference MS-011, Variation AB.
  2. Dimensions D and E1 do not include mold Flash or Protrusion.  
Mold Flash or Protrusion shall not exceed 0.25 mm (0.010").

09/28/01



2325 Orchard Parkway  
San Jose, CA 95131

**TITLE**

**28P6**, 28-lead (0.600"/15.24 mm Wide) Plastic Dual  
Inline Package (PDIP)

**DRAWING NO.**

28P6

**REV.**

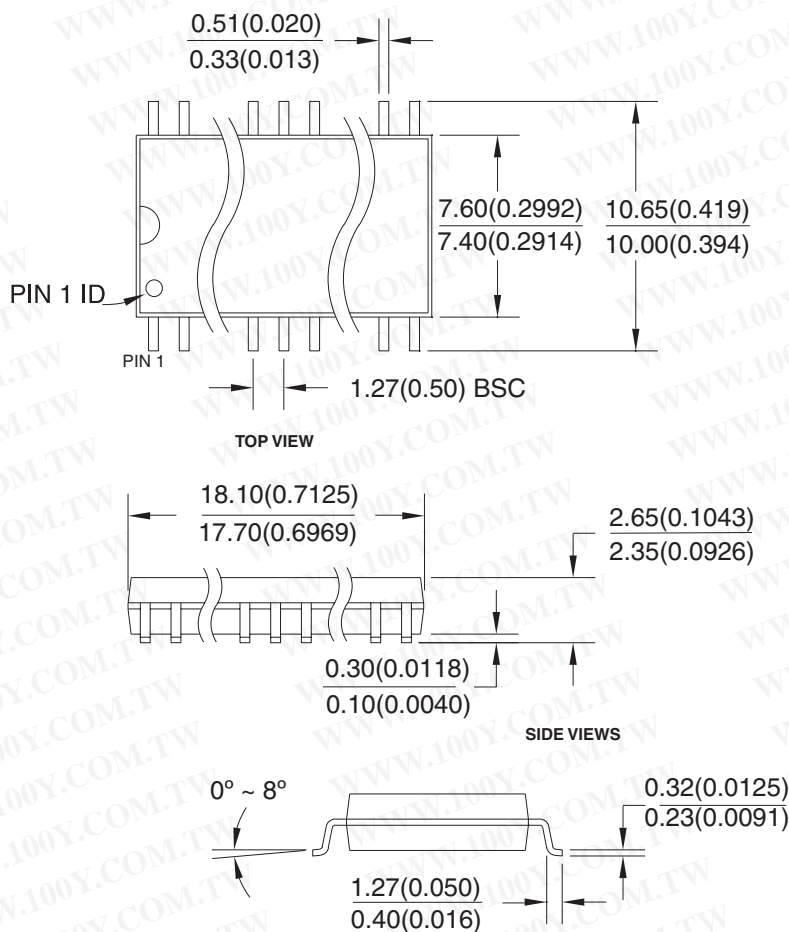
B



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[Http://www.100y.com.tw](http://www.100y.com.tw)

### 30.3 28S – SOIC

Dimensions in Millimeters and (Inches).  
Controlling dimension: Millimeters.



8/4/03



2325 Orchard Parkway  
San Jose, CA 95131

#### TITLE

**28S**, 28-lead, 0.300" Body, Plastic Gull Wing Small Outline (SOIC)  
JEDEC Standard MS-013

#### DRAWING NO.

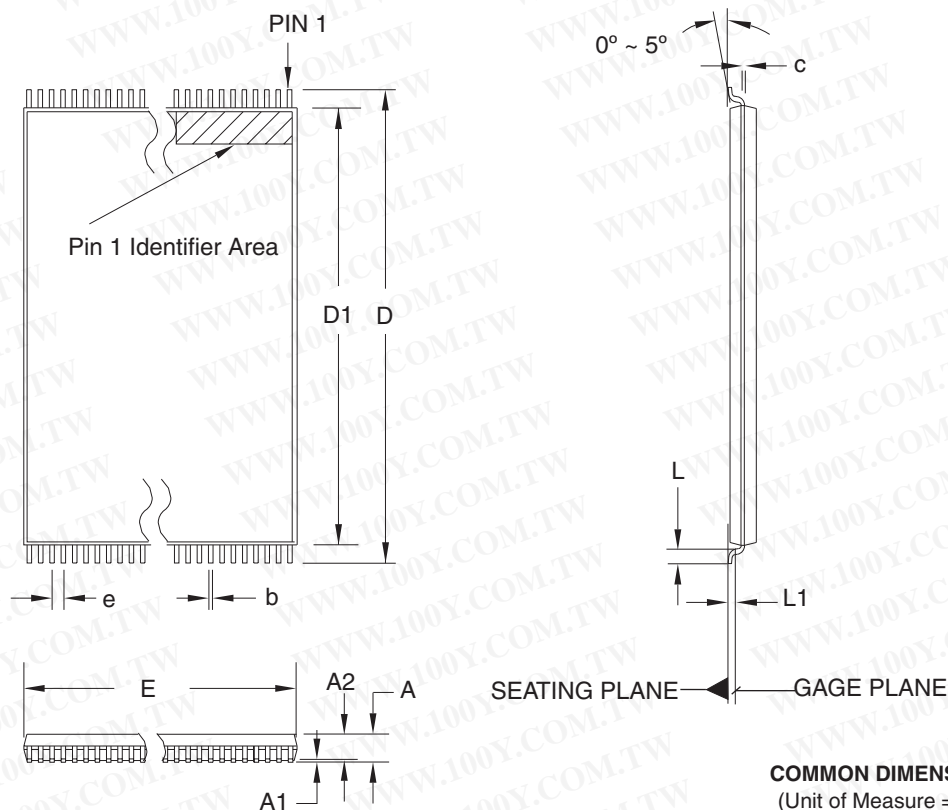
28S

#### REV.

B



## 30.4 28T – TSOP



**COMMON DIMENSIONS**  
(Unit of Measure = mm)

| SYMBOL | MIN        | NOM   | MAX   | NOTE   |
|--------|------------|-------|-------|--------|
| A      | —          | —     | 1.20  |        |
| A1     | 0.05       | —     | 0.15  |        |
| A2     | 0.90       | 1.00  | 1.05  |        |
| D      | 13.20      | 13.40 | 13.60 |        |
| D1     | 11.70      | 11.80 | 11.90 | Note 2 |
| E      | 7.90       | 8.00  | 8.10  | Note 2 |
| L      | 0.50       | 0.60  | 0.70  |        |
| L1     | 0.25 BASIC |       |       |        |
| b      | 0.17       | 0.22  | 0.27  |        |
| c      | 0.10       | —     | 0.21  |        |
| e      | 0.55 BASIC |       |       |        |

- Notes:
1. This package conforms to JEDEC reference MO-183.
  2. Dimensions D1 and E do not include mold protrusion. Allowable protrusion on E is 0.15 mm per side and on D1 is 0.25 mm per side.
  3. Lead coplanarity is 0.10 mm maximum.

12/06/02



2325 Orchard Parkway  
San Jose, CA 95131

**TITLE**

**28T**, 28-lead (8 x 13.4 mm) Plastic Thin Small Outline  
Package, Type I (TSOP)

**DRAWING NO.**

28T

**REV.**

C



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勝特力电子(深圳) 86-755-83298787  
[Http://www.100y.com.tw](http://www.100y.com.tw)



## Atmel Corporation

2325 Orchard Parkway  
San Jose, CA 95131, USA  
Tel: 1(408) 441-0311  
Fax: 1(408) 487-2600

## Regional Headquarters

### Europe

Atmel Sarl  
Route des Arsenaux 41  
Case Postale 80  
CH-1705 Fribourg  
Switzerland  
Tel: (41) 26-426-5555  
Fax: (41) 26-426-5500

### Asia

Room 1219  
Chinachem Golden Plaza  
77 Mody Road Tsimshatsui  
East Kowloon  
Hong Kong  
Tel: (852) 2721-9778  
Fax: (852) 2722-1369

### Japan

9F, Tonetsu Shinkawa Bldg.  
1-24-8 Shinkawa  
Chuo-ku, Tokyo 104-0033  
Japan  
Tel: (81) 3-3523-3551  
Fax: (81) 3-3523-7581

## Atmel Operations

### Memory

2325 Orchard Parkway  
San Jose, CA 95131, USA  
Tel: 1(408) 441-0311  
Fax: 1(408) 436-4314

### Microcontrollers

2325 Orchard Parkway  
San Jose, CA 95131, USA  
Tel: 1(408) 441-0311  
Fax: 1(408) 436-4314

La Chantrerie  
BP 70602  
44306 Nantes Cedex 3, France  
Tel: (33) 2-40-18-18-18  
Fax: (33) 2-40-18-19-60

### ASIC/ASSP/Smart Cards

Zone Industrielle  
13106 Rousset Cedex, France  
Tel: (33) 4-42-53-60-00  
Fax: (33) 4-42-53-60-01

1150 East Cheyenne Mtn. Blvd.  
Colorado Springs, CO 80906, USA  
Tel: 1(719) 576-3300  
Fax: 1(719) 540-1759

Scottish Enterprise Technology Park  
Maxwell Building  
East Kilbride G75 0QR, Scotland  
Tel: (44) 1355-803-000  
Fax: (44) 1355-242-743

### RF/Automotive

Theresienstrasse 2  
Postfach 3535  
74025 Heilbronn, Germany  
Tel: (49) 71-31-67-0  
Fax: (49) 71-31-67-2340

1150 East Cheyenne Mtn. Blvd.  
Colorado Springs, CO 80906, USA  
Tel: 1(719) 576-3300  
Fax: 1(719) 540-1759

### Biometrics/Imaging/Hi-Rel MPU/ High-Speed Converters/RF Datacom

Avenue de Rochepleine  
BP 123  
38521 Saint-Egreve Cedex, France  
Tel: (33) 4-76-58-30-00  
Fax: (33) 4-76-58-34-80

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